

Server / Telecom - Si and WBG solutions: Part 3
of 4 Editorial Series Sponsored by Infineon;
Towards Efficient, Reliable, and Cost-Effective
Power Supply Units for 5G Telecom Rectifiers
Applications Using Wide-Bandgap
Semiconductors

Author:

Francesco Di Domenico, Lead Principal
Application Engineer, Infineon Technologies

Date

05/07/2021



How to meet the design challenges of modern telecom SMPS through SiC and HV/MV GaN technologies



Power Systems Design
146 Charles Street
Annapolis, Maryland, 21401 USA

Click [here](#) to read the full article:

Towards Efficient, Reliable, and Cost-Effective Power Supply Units for 5G Telecom Rectifiers Applications Using Wide-Bandgap Semiconductors

Authored by:

Francesco Di Domenico, Lead Principal Application Engineer, Infineon Technologies